

BANKURA UNIVERSITY

(West Bengal Act XIX of 2013- Bankura University Act, 2013) Main Campus, Bankura Block-II, P.O.: Purandarpur, Dist.: Bankura, Pin- 722155, West Bengal

Office of the Registrar

No: RO/BKU/ 43 /2024 Date: 01/02 /2024

Tender Notice

Sealed quotations are invited from the reputed manufacturers, suppliers and vendors for supply and installation of EPABX intercom system for Bankura University.

The quotations are to be submitted to the Registrar, Bankura University, Bankura Block-II, P.O.- Purandarpur, Bankura, Pin-722155. Last date of submission of quotation is on 08.02.2024 up to 3.00 p.m.

Eligibility criterion of participation in the tender:

- a) Bonafide, resourceful and reliable Vendors.
- b) An undertaking should be given stating thereby that the firm has not been debarred or penalized for any reasons out of work by any Government Department.
- c) Subletting of suppliers is strictly prohibited.
- d) The prospective bidders must have valid upto date clearance of Income Tax return / Professional Tax clearance certificate / P.T (Deposit Challan) / PAN Card / **GST registration certificate**.
- e) The prospective bidders must have valid Trade License/ Enlistment.
- f) The authorised Dealers/ Vendors must have authorization certificate of dealership.
- g) The suppliers who have been delisted or debarred by any government department shall not be eligible in any way.
- h) Past performance for vender will be judged (please attached three largest clients other than the Bankura University).
- i) Rate is to be inclusive of all taxes, transport charges and installation.
- j) The rates will be valid upto 30.06.2024.
- k) The University reserves the right to accept or reject any quotation without assigning any reason whatsoever.

Detail specifications of the items are given below:

Sl. No.		Item Name & Specification	Quantity	
1	1.	Pair Count: 20 PAIR Insulation Core Material: Jelly Filled Armoured High- Density Poly-Ethelene Core Dia: 0.5mm Conductive Material: CopperLength - 300 mtr		
	2.	Cable Pair Count: 4 pair Insulation Core Material: Jelly Filled unarmoured High-Density Poly-Ethelene Core Dia: 0.5mm Conductive Material: Copper Length - 0.5mm copper req - 45 coil (90M)	1 Unit	
	3.	Pair Count: 6 PAIR Insulation Core Material: Jelly Filled Armoured High- Density Poly-EtheleneCore Dia: 0.5mm Conductive Material: CopperLength - 300 mtr		
	4.	20 pair krone module With MDF Box req 2 Unit		
	5.	10 pair krone module With MDF Box req 2 Unit		
	6.	30 pair krone module With MDF Box req 1 Unit		
		Krone Technical data: IP 54 acc. to DIN 40050, polystyrole blend, 10 pairs-20° C to +60° C		

- 7. Alphanumeric With CLI corded land line set req 30 unit
- 8. RJ11 I/O module With Pure Copper Gold Plated Conductive Contact HdPE Box 30 unit
- 9. 6 Pair Krone Modules with MDF BOX 6 Unit

10. 4 in 32 Out PBX With Below Specs

Tech	Range				
Specs	/ Data				
Universal slots	4				
FXS Ports (SLT)	32				
DKP Port	16				
IP User	100				
FXO Ports (CO)	16				
SIP Trunks	50				
Max. VoIP Channel	64				
Max. VMS Channel	16				
Max. IP to IP Call	32				
(Transcoding)					
Max. IP to IP Call	64				
(DRTP/Relay RTP)					
Max. IP to TDM Call	64				
Max. TDM to TDM	Non-Blocking				
VoIP Protocol	SIP, SDP, RTP, SRTP				
Network Protocol	IPV6, IPV4, TCP, UDP, VLAN, DHCP, PPPoE, QoS, STUN				
Transport Protocol	UDP, TCP, TLS				
Codec	G.711(A-law, μ-law), G.723,G.729AB,GSM- FR,iLBC				
DTMF	RTP(RFC2833), SIP Info, IN-Band				
LAN	Gigabit port				
WAN	Gigabit port				
Environment	Operation Range: 0°C to 45°C,				
	Storage Range: -20°C to +70°C,				
	Operating Humidity: 5-95% RH Non- Condensing				
Mounting	1U Rack Mount				

Sd/-Dr. Saurabh Dutta Registrar (Addl. Charge) Bankura University

Date:01/02/2024

Memo No. RO/BKU/ 43 /1(5)/24

Copy Forwarded to:

- 1. The Finance Officer, Bankura University.
- 2. System Administrator, Bankura University with a request to upload the notice in the university website
- 3. Central Store, Bankura University
- 4. Office Notice Board.
- 5. Guard file

Sd/-Dr. Saurabh Dutta Registrar (Addl. Charge) Bankura University